

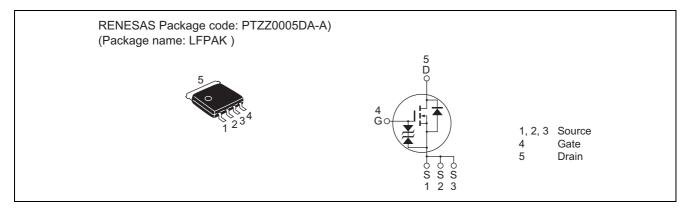
HAT2175H Silicon N Channel Power MOS FET Power Switching

REJ03G0006-0400 Rev.4.00 Sep 20, 2005

Features

- Capable of 8 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
- $R_{DS(on)} = 33 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
ltem	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	± 20	V
Drain current	I _D	15	A
Drain peak current	Note1 I _{D(pulse)}	60	A
Body-drain diode reverse drain current	I _{DR}	15	A
Avalanche current	I _{AP} Note 2	15	A
Avalanche energy	E _{AR} Note 2	22.5	mJ
Channel dissipation	Pch ^{Note3}	15	W
Channel to Case Thermal Resistance	θch-C	8.34	°C/W
Channel temperature	Tch	150	٥C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at Tch = 25° C, Rg $\geq 50 \Omega$

3. $Tc = 25^{\circ}C$



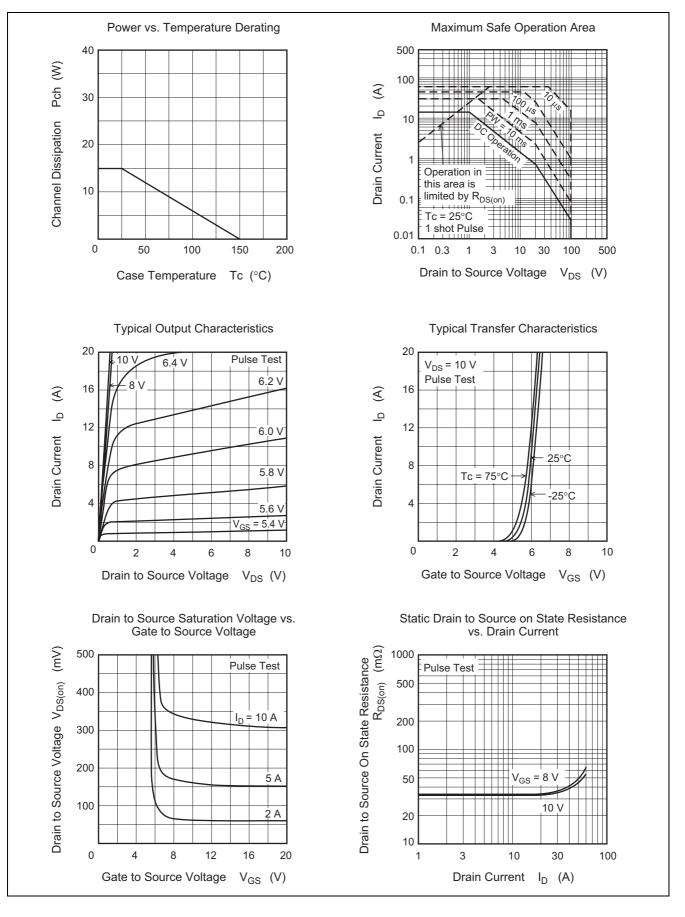
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	100	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	± 20			V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	± 10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μA	$V_{DS} = 100 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	4.0	_	6.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{mA}$
Static drain to source on state	R _{DS(on)}	_	33	42	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	34	46	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 8 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	15	25		S	$I_D = 7.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	1445	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	_	185	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss		61	_	pF	
Gate Resistance	Rg	_	0.55	_	Ω	
Total gate charge	Qg	_	21	_	nC	$V_{DD} = 50 \text{ V}, V_{GS} = 10 \text{ V},$
Gate to source charge	Qgs	_	8	_	nC	I _D = 15 A
Gate to drain charge	Qgd	_	4.5	_	nC	
Turn-on delay time	t _{d(on)}	_	17	_	ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.5 \text{ A},$
Rise time	tr	_	8.2	_	ns	$V_{DD} \cong 30 \text{ V}, \text{ R}_{L} = 4 \Omega,$ Rg = 4.7 Ω
Turn-off delay time	t _{d(off)}	_	28	_	ns	
Fall time	t _f	_	4.7	_	ns	
Body–drain diode forward voltage	V _{DF}	_	0.84	1.10	V	$IF = 15 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t _{rr}	_	45	_	ns	$IF = 15 A, V_{GS} = 0,$
time						di _F / dt = 100 A/ μs

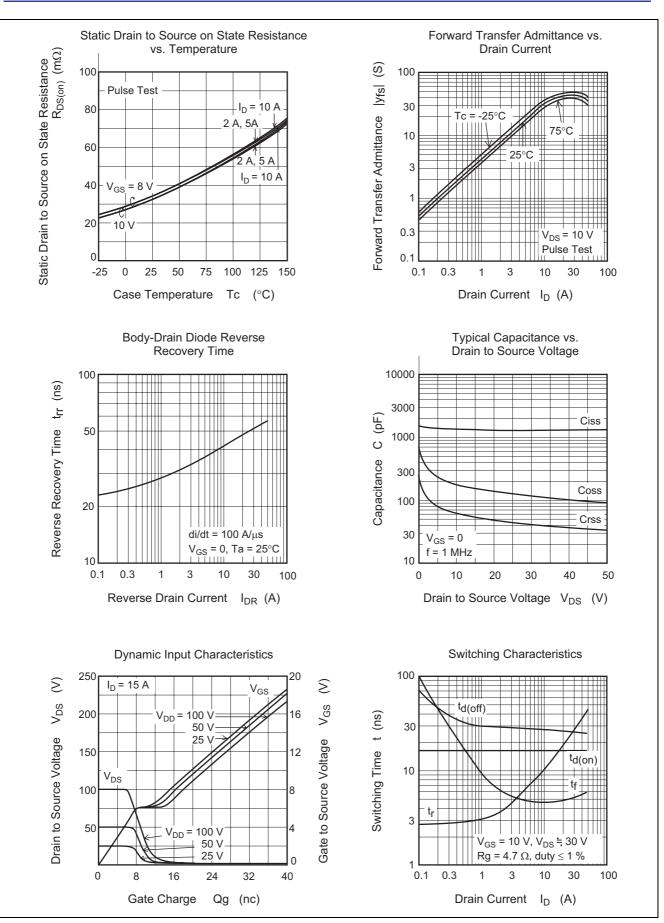
Notes: 4. Pulse test



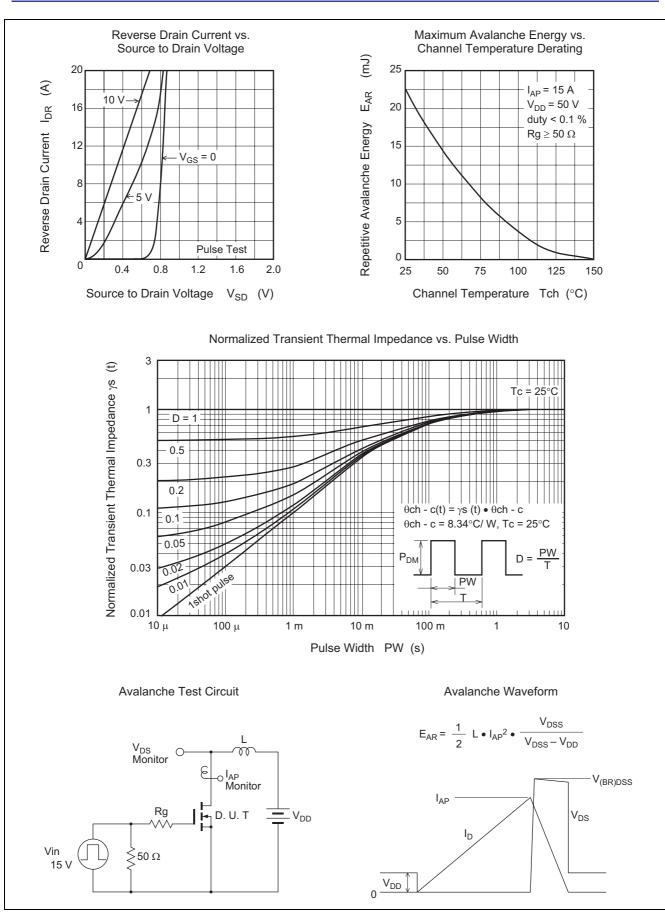
Main Characteristics



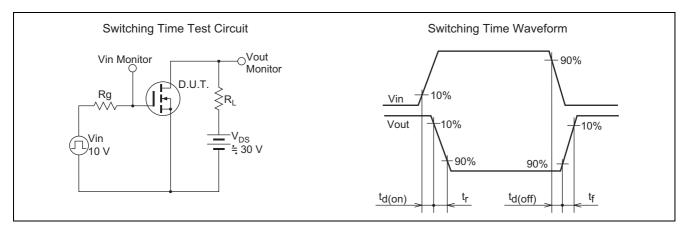






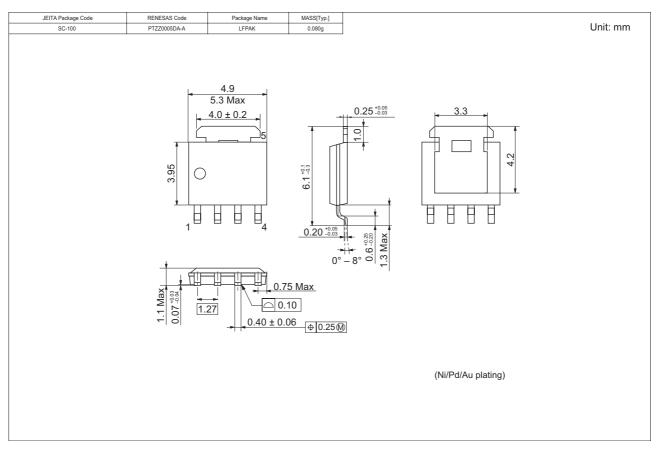








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2175H-EL-E	2500 pcs	Taping

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